

FPC CONNECTORS







PRODUCT DRAWING



♣ 3D PDF

TE CONNECTIVITY (TE)

EMBOSS TAPING 0.3FPC NARROW BF

Fine Pitch FPC | Fine Pitch FPC

1-2013496-0

TE Internal Number: 1-2013496-0

Always EU RoHS/ELV Compliant

Centerline .3 mm [.012 in]

Number of Positions 29

Insertion Force **ZIF**

PCB Mounting Orientation Right Angle

Termination Method to PC Board Surface Mount

Product Drawings

0.3FPC Narrow BF-L-1.2H 1.2mmH, 2.9mmW, GOLD PLATE

PDF **English**

CAD Files

3D PDF

PDF

Customer View Model

2D_DXF.ZIP English

Customer View Model

3D_IGS.ZIP English

Customer View Model

3D STP.ZIP English

Catalog Pages/Data Sheets

8-1773459-2_Fine_Pitch_FPC_conn_QRG

PDF **English**

Product Specifications

Product Specification 0.3FPC NARROW Spec.

Japanese

0.3FPC NARROW Spec.

PDF Japanese

Qualification Test Report 0.3FPC Narrow BF-L-1.2H

PDF **Japanese**

0.3FPC Narrow BF-L-1.2H

Japanese

Instruction Sheets

U.SEPC INAFFOW DE-L

TIF Japanese

0.3FPC Narrow BF-L

PDF **Japanese**

Please review product documents or contact us for the latest agency approval information. Please Note: Use the Product Drawing for all design activity.

Product Type Features	Insertion Force	ZIF	
	PCB Mounting Orientation	Right Angle	
	Actuator Type	Rear Flip (Front Hinge)	
	Shrouded	Yes	
	Applies To	Flexible Printed Circuit (FPC), Printed Circuit Board	
	Product Type	Connector	
	Connector System	Flex-to-Board	
	Connector Type	Connector Assembly	
	Sealed	No	
	Wire/Cable Type	FPC/FFC	
	Shielded	No	
	Series	FPC	
	Connector Style	Receptacle	
	Type of Connector	ZIF FPC	
Configuration Features	Number of Positions	29	
	Number of Rows	1	
	Tail Orientation	Staggered	
Electrical Characteristics	Operating Voltage	50 VAC [50 VDC]	
3ody Features	Cable Entry	Horizontal	
	Color	Black/Natural	
Contact Features	Contact Mating Location	Bottom	
	Contact Termination Area Plating Thickness	.1 μm [3.93 μin]	
	Contact Current Rating (Max) (A)	.2	
	Contact Mating Area Plating Thickness	.1 μm [3.937 μin]	
	Contact Transmits (Typical)	Signal (Data)	

	Contact Mating Area Plating Material	Gold	
	Contact Base Material	Copper Alloy	
	Contact Type	Socket	
	Contact Design	Single Beam	
	Contact Termination Area Plating Material	Gold	
	Solder Tail Contact Plating Material	Gold over Nickel	
Termination Features	Termination Method to PC Board	Surface Mount	
Mechanical Attachment	PCB Mount Alignment	Without	
	PCB Mount Retention	With	
	Mating Alignment	With	
	PCB Mount Retention Type	Solder Pads	
Housing Features	Centerline	.3 mm [.012 in]	
	Housing Color	Beige	
	Housing Material	LCP (Liquid Crystal Polymer)	
Dimensions	Height	1.2 mm [.047 in]	
	Width	2.9 mm [.114 in]	
	Flex Cable Thickness	.2 mm [.00787 in]	
	Tail Length	.6 mm [.024 in]	
	Length	10.5 mm [.413 in]	
Usage Conditions	Operating Temperature Range	-25 – 85 °C [-13 – 185 °F]	
	Flame Retardant	Yes	
ldentification Marking	Circuit Identification Feature	Without	
Industry Standards	UL Flammability Rating	UL 94V-0	
Packaging Features	Packaging Method	Tape & Reel	
	Packaging Quantity	4000	
Product Compliance	Statement of Compliance		

VIEW ALL PRODUCT COMPLIANCE